NEC

## DATA SHEET

#### Solid State Relay OCMOS FET

# **PS710CL2-1A**

### 4-PIN DIP, 0.1 Ω LOW ON-STATE RESISTANCE 2.0 A CONTINUOUS LOAD CURRENT 1-ch Optical Coupled MOS FET

-NEPOC Series-

#### DESCRIPTION

The PS710CL2-1A is a solid state relay containing a GaAs LED on the input side and MOS FETs on the output side.

It is suitable for PLC, etc. because of its large continuous load current and low on-state resistance.

The PS710CL2-1A has a surface mount type with 10.16 mm lead pitch.

#### FEATURES

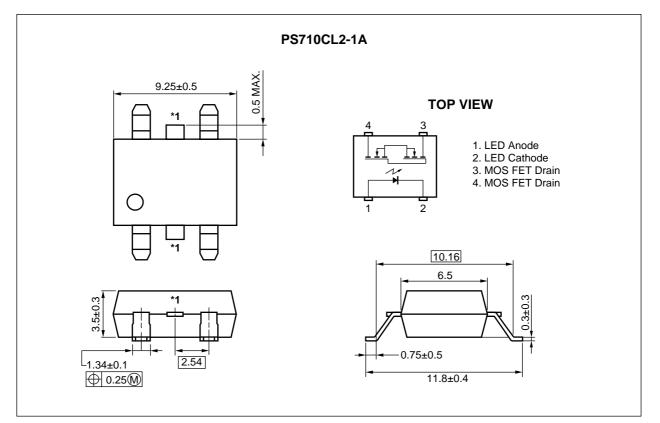
- Low on-state resistance ( $R_{on} = 0.1 \Omega TYP$ .)
- Large continuous load current (I<sub>L</sub> = 2.0 A)
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (4-pin DIP)
- Low offset voltage
- Ordering number of taping product: PS710CL2-1A-E3, E4

#### **APPLICATIONS**

- Measurement equipment
- FA equipment

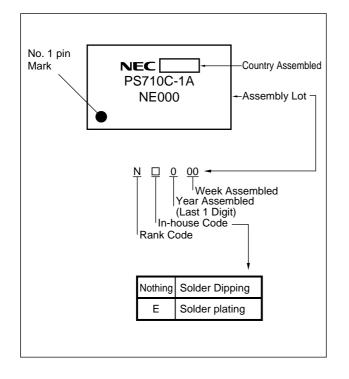
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#### PACKAGE DIMENSIONS (UNIT: mm)



\*1 Cut the lead

#### MARKING EXAMPLE



#### ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number <sup>*1</sup>
PS710CL2-1A	4-pin DIP	Magazine case 50 pcs	PS710CL2-1A
PS710CL2-1A-E3		Embossed Tape 1 000 pcs/reel	
PS710CL2-1A-E4			

\*1 For the application of the Safety Standard, following part number should be used.

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)		lf	50	mA
	Reverse Voltage		VR	5.0	V
	Power Dissipation		PD	50	mW
	Peak Forward Current		IFP	1	А
MOS FET	Load Voltage		VL	60	V
	Continuous	Connection A	١L	2.0	А
	Load Current <sup>*2</sup>				
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)		Ilp	4.0	A
	Power Dissipation		PD	600	mW
Isolation Voltage <sup>*</sup>		BV	1 500	Vr.m.s.	
Total Power Dissipation		Ρτ	650	mW	
Operating Ambient Temperature		TA	-40 to +85	°C	
Storage Temperature		Tstg	-40 to +100	°C	

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

\*1 PW = 100  $\mu$ s, Duty Cycle = 1%

\*2 Conditions: IF  $\geq$  2 mA. The following types of load connections are available.



\*3 PW = 100 ms, 1 shot

\*4 AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output

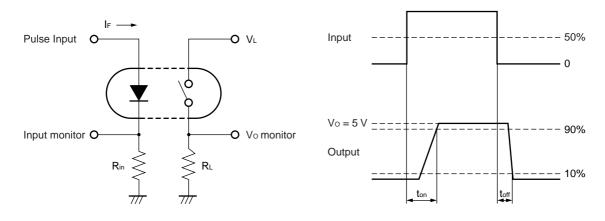
#### **RECOMMENDED OPERATING CONDITIONS (TA = 25°C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

#### ELECTRICAL CHARACTERISTICS (TA = 25°C)

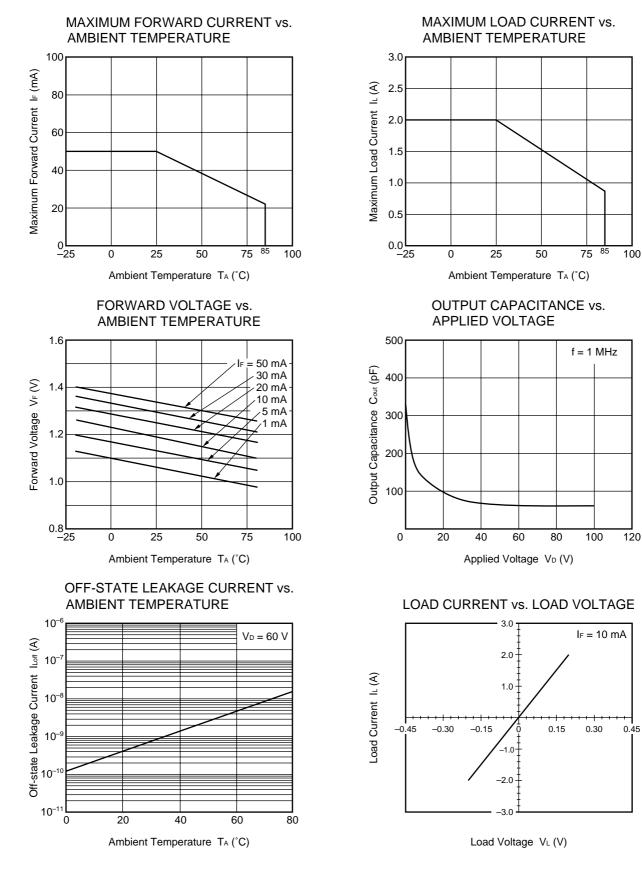
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V <sub>R</sub> = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 60 V			1.0	μA
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		320		pF
Coupled	LED On-state Current	IFon	IL = 2.0 A			2.0	mA
	On-state Resistance	Ron	$I_{\text{F}}$ = 10 mA, $I_{\text{L}}$ = 2.0 A, $t \leq$ 10 ms		0.1	0.15	Ω
	Turn-on Time <sup>*1, 2</sup>	ton	$I_{F} = 10 \text{ mA}, \text{ Vo} = 5 \text{ V}, \text{ R}_{L} = 500 \Omega,$		1.0	3.0	ms
	Turn-off Time <sup>*1, 2</sup>	toff	PW ≥ 10 ms		0.05	1.0	
	Isolation Resistance	Rı-o	VI-O = 1.0 kVDC	10 <sup>9</sup>			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		0.5		pF

\*1 Test Circuit for Switching Time

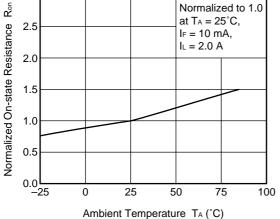


\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
 Be aware that when the device operates with an input-pulse width of under 10 ms, the turn-on time and turn-off time will increase.

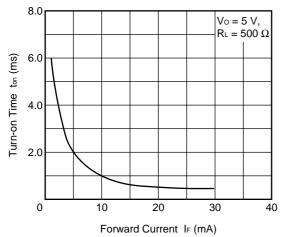
#### TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)



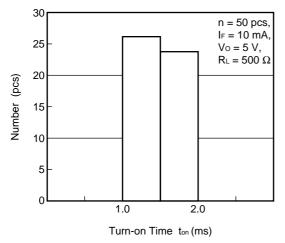
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



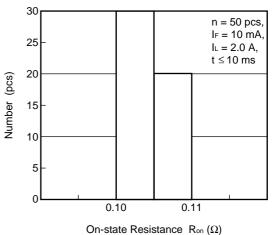
#### TURN-ON TIME vs. FORWARD CURRENT



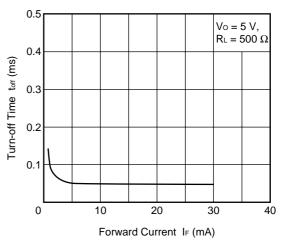
#### TURN-ON TIME DISTRIBUTION



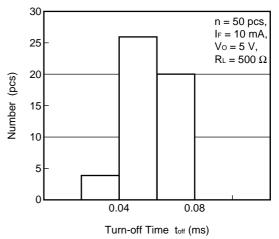
#### **ON-STATE RESISTANCE DISTRIBUTION**

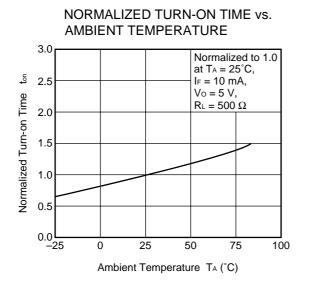


#### TURN-OFF TIME vs. FORWARD CURRENT

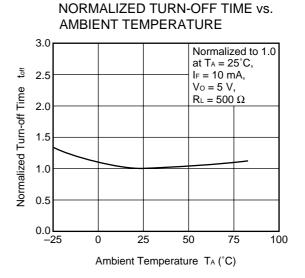


#### TURN-OFF TIME DISTRIBUTION

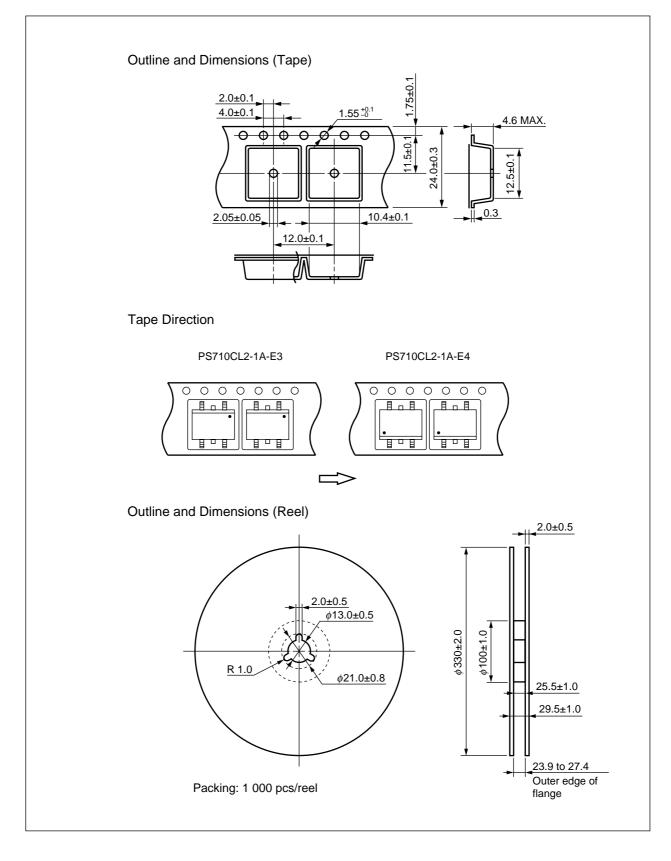




Remark The graphs indicate nominal characteristics.



#### TAPING SPECIFICATIONS (UNIT: mm)



#### **RECOMMENDED SOLDERING CONDITIONS**

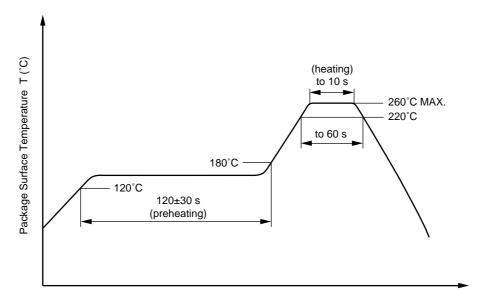
#### (1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
   One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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M8E 00.4-0110

#### SAFETY INFORMATION ON THIS PRODUCT

Caution GaAs Products	The product contains gallium arsenide, GaAs. GaAs vapor and powder are hazardous to human health if inhaled or ingested.		
	Do not destroy or burn the product.		
	Do not cut or cleave off any part of the product.		
	Do not crush or chemically dissolve the product.		
	Do not put the product in the mouth.		
	Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.		

#### ▶ Business issue

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#### ► Technical issue

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